

# FCP7N60/FCPF7N60/FCPF7N60YDTU

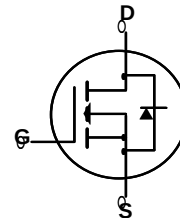
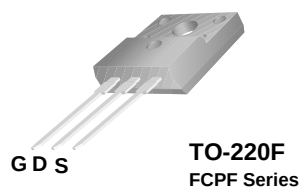
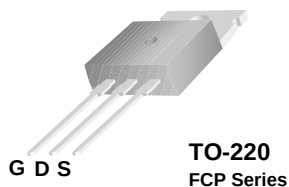
## Features

- 650V @ $T_J = 150^\circ\text{C}$
- Typ.  $R_{DS(on)} = 0.53\Omega$
- Ultra low gate charge (typ.  $Q_g = 25\text{nC}$ )
- Low effective output capacitance (typ.  $C_{oss,eff} = 60\text{pF}$ )
- 100% avalanche tested

## Description

SuperFET™ is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme  $dv/dt$  rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



## Absolute Maximum Ratings

| Symbol         | Parameter                                                                                                | FCP7N60     | FCPF7N60 | Unit                |
|----------------|----------------------------------------------------------------------------------------------------------|-------------|----------|---------------------|
| $V_{DSS}$      | Drain-Source Voltage                                                                                     | 600         |          | V                   |
| $I_D$          | Drain Current<br>- Continuous ( $T_C = 25^\circ\text{C}$ )<br>- Continuous ( $T_C = 100^\circ\text{C}$ ) | 7           | 7*       | A                   |
|                |                                                                                                          | 4.4         | 4.4*     | A                   |
| $I_{DM}$       | Drain Current - Pulsed (Note 1)                                                                          | 21          | 21*      | A                   |
| $V_{GSS}$      | Gate-Source voltage                                                                                      | $\pm 30$    |          | V                   |
| $E_{AS}$       | Single Pulsed Avalanche Energy (Note 2)                                                                  | 230         |          | mJ                  |
| $I_{AR}$       | Avalanche Current (Note 1)                                                                               | 7           |          | A                   |
| $E_{AR}$       | Repetitive Avalanche Energy (Note 1)                                                                     | 8.3         |          | mJ                  |
| $dv/dt$        | Peak Diode Recovery $dv/dt$ (Note 3)                                                                     | 4.5         |          | V/ns                |
| $P_D$          | Power Dissipation ( $T_C = 25^\circ\text{C}$ )<br>- Derate above $25^\circ\text{C}$                      | 83          | 31       | W                   |
|                |                                                                                                          | 0.67        | 0.25     | W/ $^\circ\text{C}$ |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                                                                  | -55 to +150 |          | $^\circ\text{C}$    |
| $T_L$          | Maximum Lead Temperature for Soldering Purpose,<br>1/8" from Case for 5 Seconds                          | 300         |          | $^\circ\text{C}$    |

\*Drain current limited by maximum junction temperature

## Thermal Characteristics

| Symbol          | Parameter                               | FCP7N60 | FCPF7N60 | Unit               |
|-----------------|-----------------------------------------|---------|----------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case    | 1.5     | 4.0      | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 62.5    | 62.5     | $^\circ\text{C/W}$ |

## Package Marking and Ordering Information

| Device Marking | Device       | Package           | Reel Size | Tape Width | Quantity |
|----------------|--------------|-------------------|-----------|------------|----------|
| FCP7N60        | FCP7N60      | TO-220            | -         | -          | 50       |
| FCPF7N60       | FCPF7N60     | TO-220F           | -         | -          | 50       |
| FCPF7N60       | FCPF7N60YDTU | TO-220F (Forming) | -         | -          | 50       |

## Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

| Symbol                                                 | Parameter                                             | Conditions                                                                           | Min | Typ  | Max  | Units |
|--------------------------------------------------------|-------------------------------------------------------|--------------------------------------------------------------------------------------|-----|------|------|-------|
| Off Characteristics                                    |                                                       |                                                                                      |     |      |      |       |
| BV <sub>DSS</sub>                                      | Drain-Source Breakdown Voltage                        | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 25°C                  | 600 | --   | --   | V     |
|                                                        |                                                       | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 150°C                 | --  | 650  | --   | V     |
| ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>                   | Breakdown Voltage Temperature Coefficient             | I <sub>D</sub> = 250μA, Referenced to 25°C                                           | --  | 0.6  | --   | V/°C  |
| BV <sub>DS</sub>                                       | Drain-Source Avalanche Breakdown Voltage              | V <sub>GS</sub> = 0V, I <sub>D</sub> = 7A                                            | --  | 700  | --   | V     |
| I <sub>DSS</sub>                                       | Zero Gate Voltage Drain Current                       | V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V                                         | --  | --   | 1    | μA    |
|                                                        |                                                       | V <sub>DS</sub> = 480V, T <sub>C</sub> = 125°C                                       | --  | --   | 10   | μA    |
| I <sub>GSSF</sub>                                      | Gate-Body Leakage Current, Forward                    | V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V                                          | --  | --   | 100  | nA    |
| I <sub>GSSR</sub>                                      | Gate-Body Leakage Current, Reverse                    | V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V                                         | --  | --   | -100 | nA    |
| On Characteristics                                     |                                                       |                                                                                      |     |      |      |       |
| V <sub>GS(th)</sub>                                    | Gate Threshold Voltage                                | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                           | 3.0 | --   | 5.0  | V     |
| R <sub>DS(on)</sub>                                    | Static Drain-Source On-Resistance                     | V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.5A                                         | --  | 0.53 | 0.6  | Ω     |
| g <sub>FS</sub>                                        | Forward Transconductance                              | V <sub>DS</sub> = 40V, I <sub>D</sub> = 3.5A                                         | --  | 6    | --   | S     |
| Dynamic Characteristics                                |                                                       |                                                                                      |     |      |      |       |
| C <sub>iss</sub>                                       | Input Capacitance                                     | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz                              | --  | 710  | 920  | pF    |
| C <sub>oss</sub>                                       | Output Capacitance                                    |                                                                                      | --  | 380  | 500  | pF    |
| C <sub>rss</sub>                                       | Reverse Transfer Capacitance                          |                                                                                      | --  | 34   | --   | pF    |
| C <sub>oss</sub>                                       | Output Capacitance                                    | V <sub>DS</sub> = 480V, V <sub>GS</sub> = 0V, f = 1.0MHz                             | --  | 22   | 29   | pF    |
| C <sub>oss eff.</sub>                                  | Effective Output Capacitance                          | V <sub>DS</sub> = 0V to 400V, V <sub>GS</sub> = 0V                                   | --  | 60   | --   | pF    |
| Switching Characteristics                              |                                                       |                                                                                      |     |      |      |       |
| t <sub>d(on)</sub>                                     | Turn-On Delay Time                                    | V <sub>DD</sub> = 300V, I <sub>D</sub> = 7A<br>R <sub>G</sub> = 25Ω<br><br>(Note 4)  | --  | 35   | 80   | ns    |
| t <sub>r</sub>                                         | Turn-On Rise Time                                     |                                                                                      | --  | 55   | 120  | ns    |
| t <sub>d(off)</sub>                                    | Turn-Off Delay Time                                   |                                                                                      | --  | 75   | 160  | ns    |
| t <sub>f</sub>                                         | Turn-Off Fall Time                                    |                                                                                      | --  | 32   | 75   | ns    |
| Q <sub>g</sub>                                         | Total Gate Charge                                     | V <sub>DS</sub> = 480V, I <sub>D</sub> = 7A<br>V <sub>GS</sub> = 10V<br><br>(Note 4) | --  | 23   | 30   | nC    |
| Q <sub>gs</sub>                                        | Gate-Source Charge                                    |                                                                                      | --  | 4.2  | 5.5  | nC    |
| Q <sub>gd</sub>                                        | Gate-Drain Charge                                     |                                                                                      | --  | 11.5 | --   | nC    |
| Drain-Source Diode Characteristics and Maximum Ratings |                                                       |                                                                                      |     |      |      |       |
| I <sub>S</sub>                                         | Maximum Continuous Drain-Source Diode Forward Current |                                                                                      | --  | --   | 7    | A     |
| I <sub>SM</sub>                                        | Maximum Pulsed Drain-Source Diode Forward Current     |                                                                                      | --  | --   | 21   | A     |
| V <sub>SD</sub>                                        | Drain-Source Diode Forward Voltage                    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 7A                                            | --  | --   | 1.4  | V     |
| t <sub>rr</sub>                                        | Reverse Recovery Time                                 | V <sub>GS</sub> = 0V, I <sub>S</sub> = 7A                                            | --  | 360  | --   | ns    |
| Q <sub>rr</sub>                                        | Reverse Recovery Charge                               | di <sub>F</sub> /dt = 100A/μs                                                        | --  | 4.5  | --   | μC    |

### NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I<sub>AS</sub> = 3.5A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25Ω, Starting T<sub>J</sub> = 25°C
3. I<sub>SD</sub> ≤ 7A, di/dt ≤ 200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics

## Typical Performance Characteristics

Figure 1. On-Region Characteristics

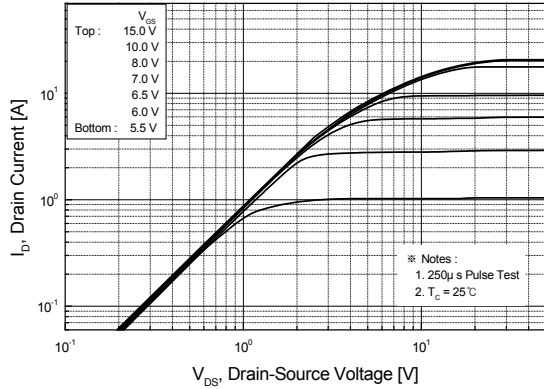


Figure 2. Transfer Characteristics

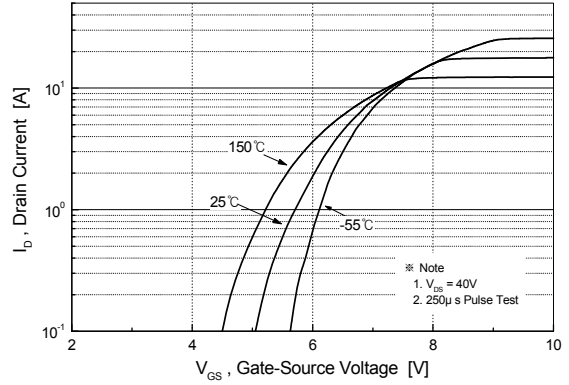


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

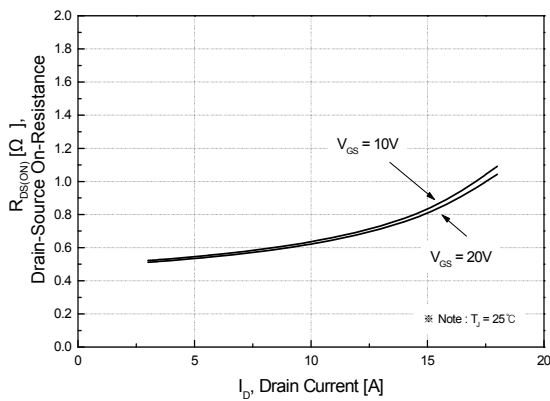


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

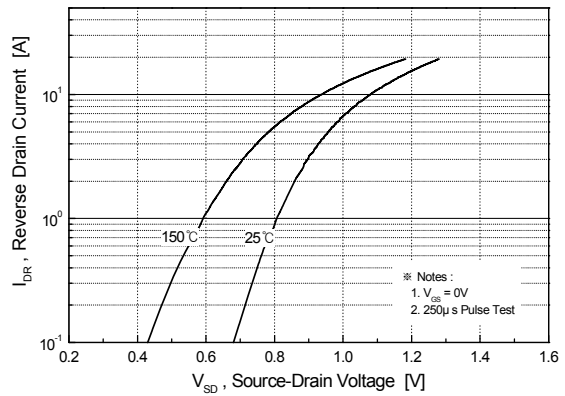


Figure 5. Capacitance Characteristics

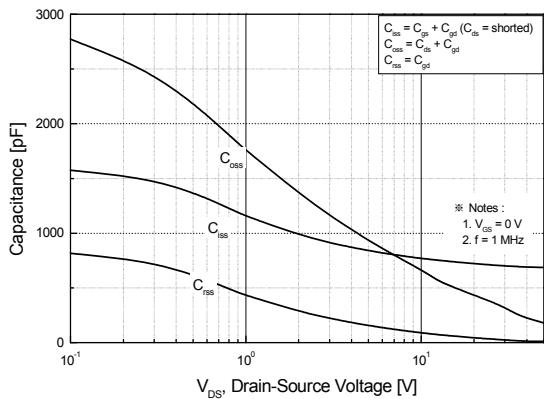
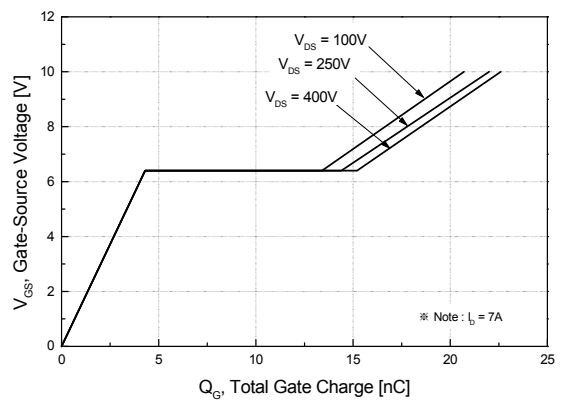
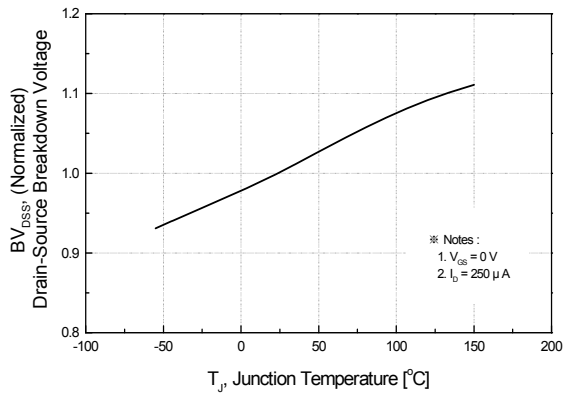


Figure 6. Gate Charge Characteristics

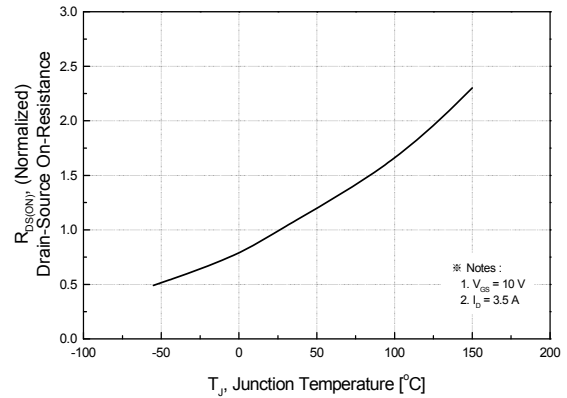


## Typical Performance Characteristics (Continued)

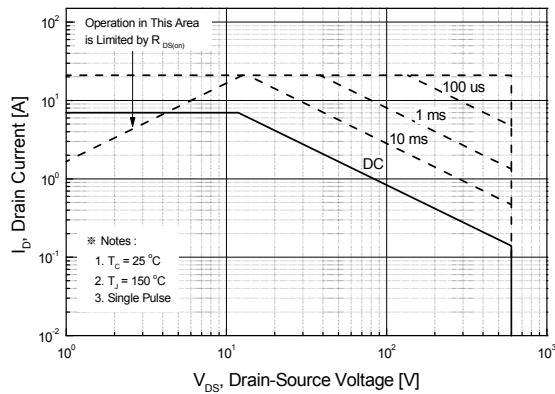
**Figure 7. Breakdown Voltage Variation vs. Temperature**



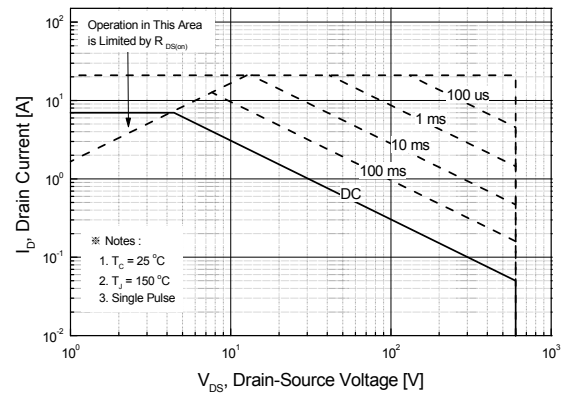
**Figure 8. On-Resistance Variation vs. Temperature**



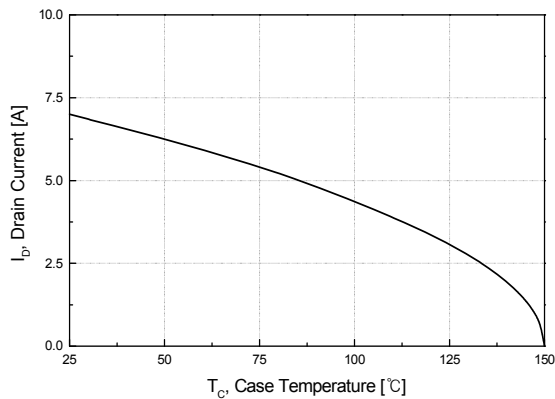
**Figure 9-1. Maximum Safe Operating Area for FCP7N60**



**Figure 9-2. Maximum Safe Operating Area for FCPF7N60**



**Figure 10. Maximum Drain Current vs. Case Temperature**



## Typical Performance Characteristics (Continued)

Figure 11-1. Transient Thermal Response Curve for FCP7N60

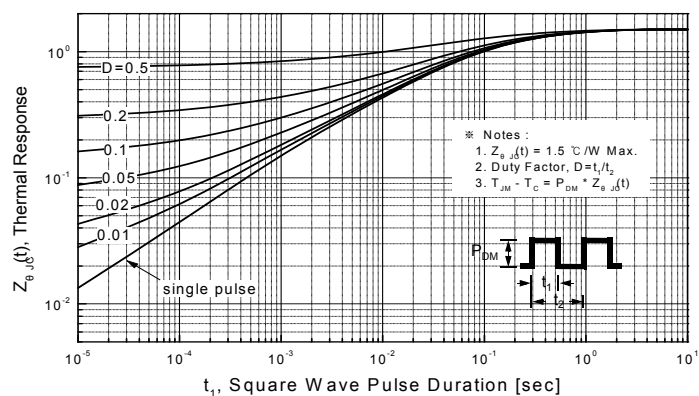
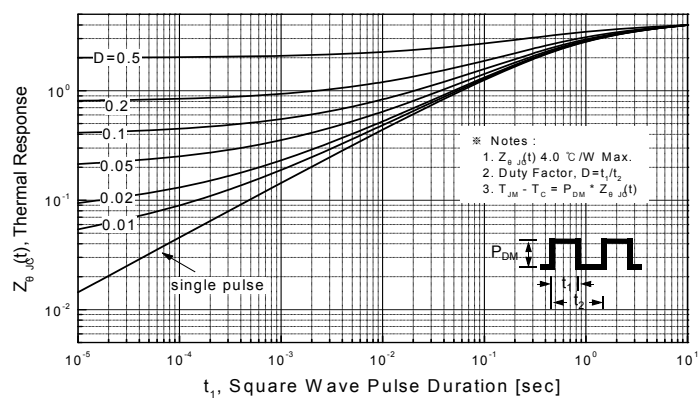
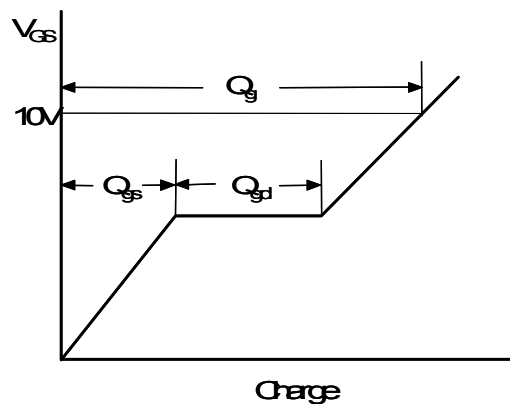
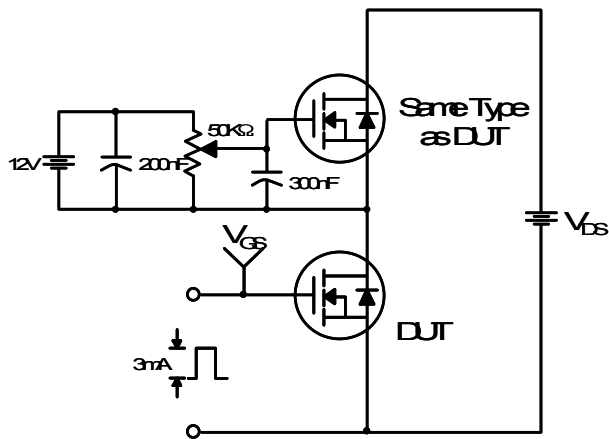


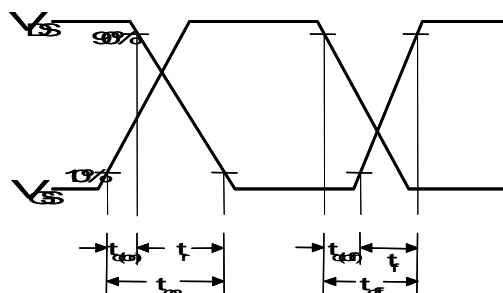
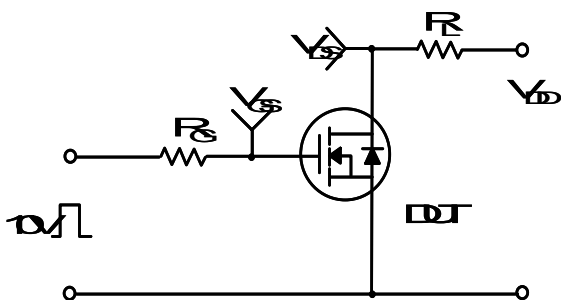
Figure 11-2. Transient Thermal Response Curve for FCPF7N60



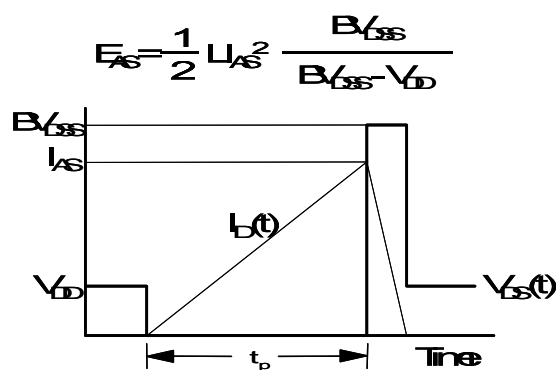
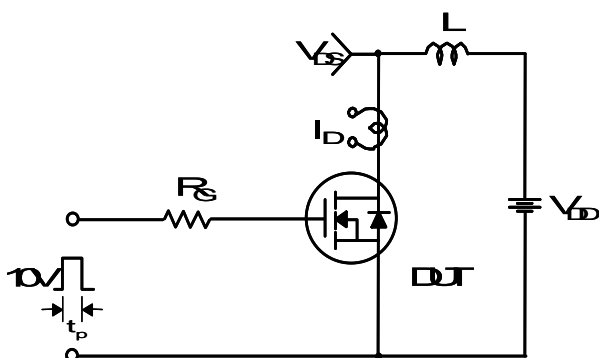
Gate Charge Test Circuit & Waveform



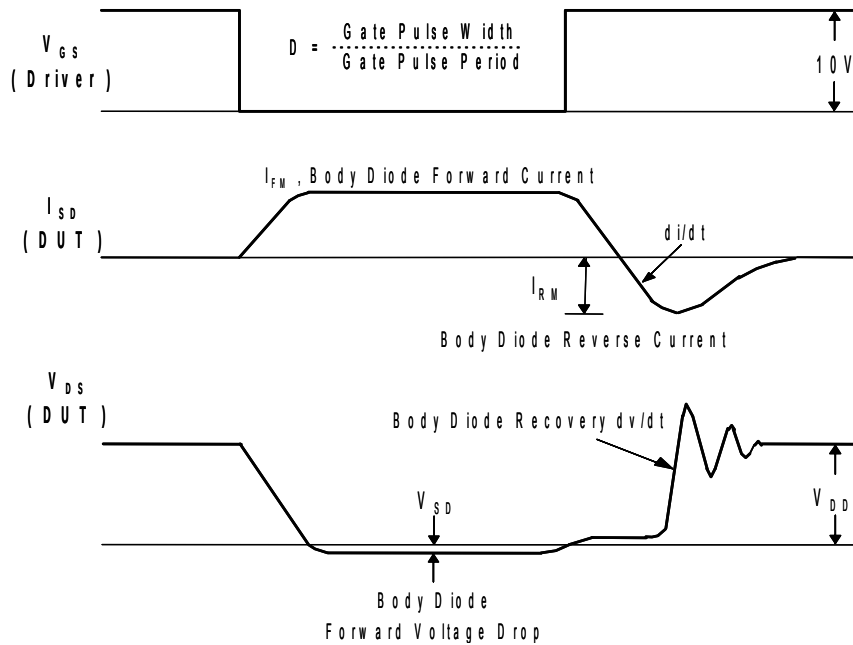
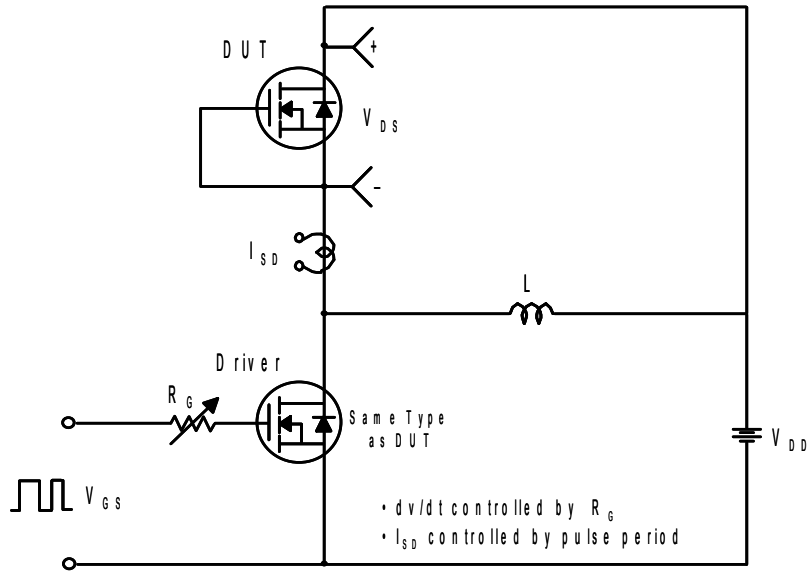
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

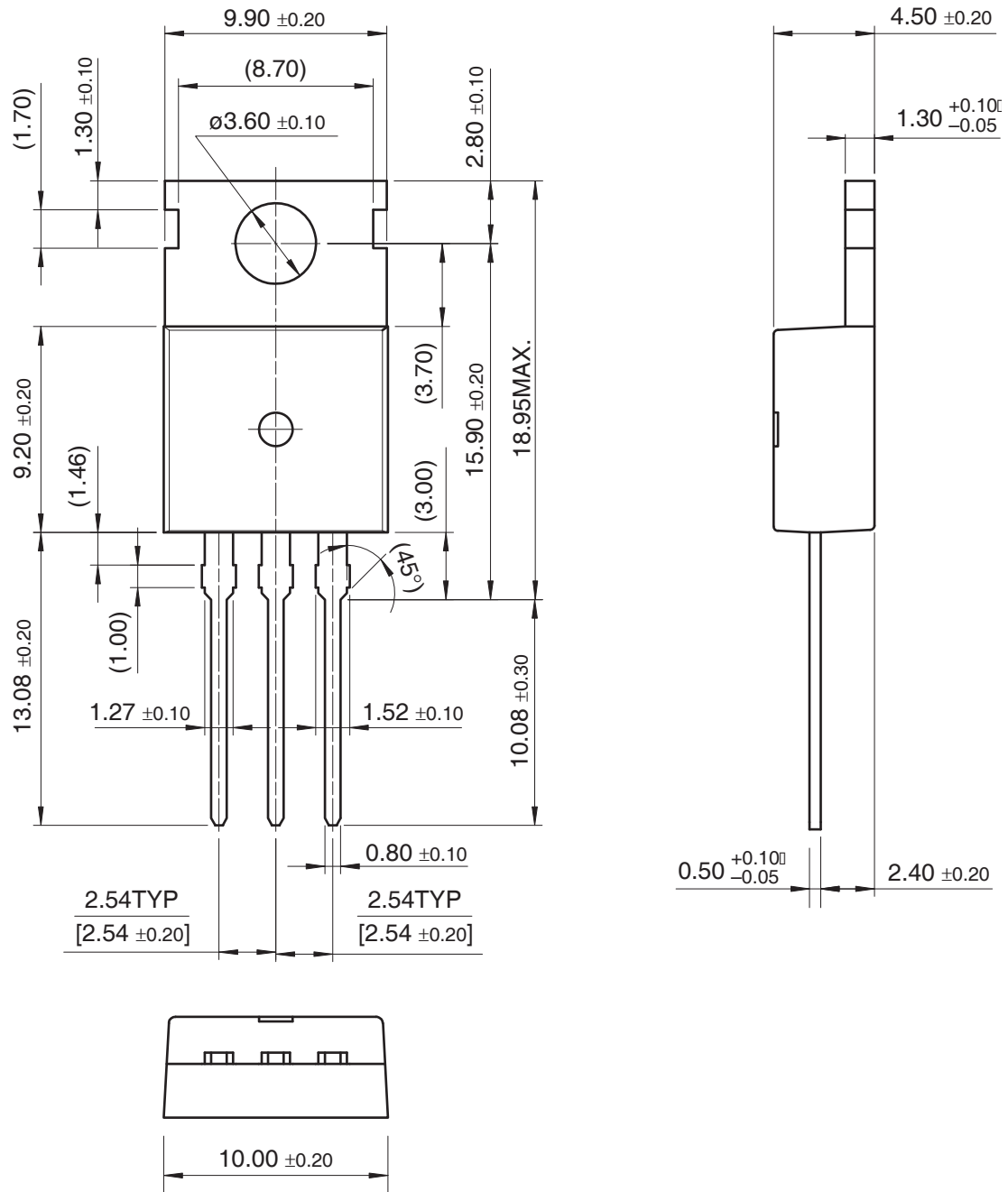


# Peak Diode Recovery dv/dt Test Circuit & Waveforms



# Mechanical Dimensions

## TO-220

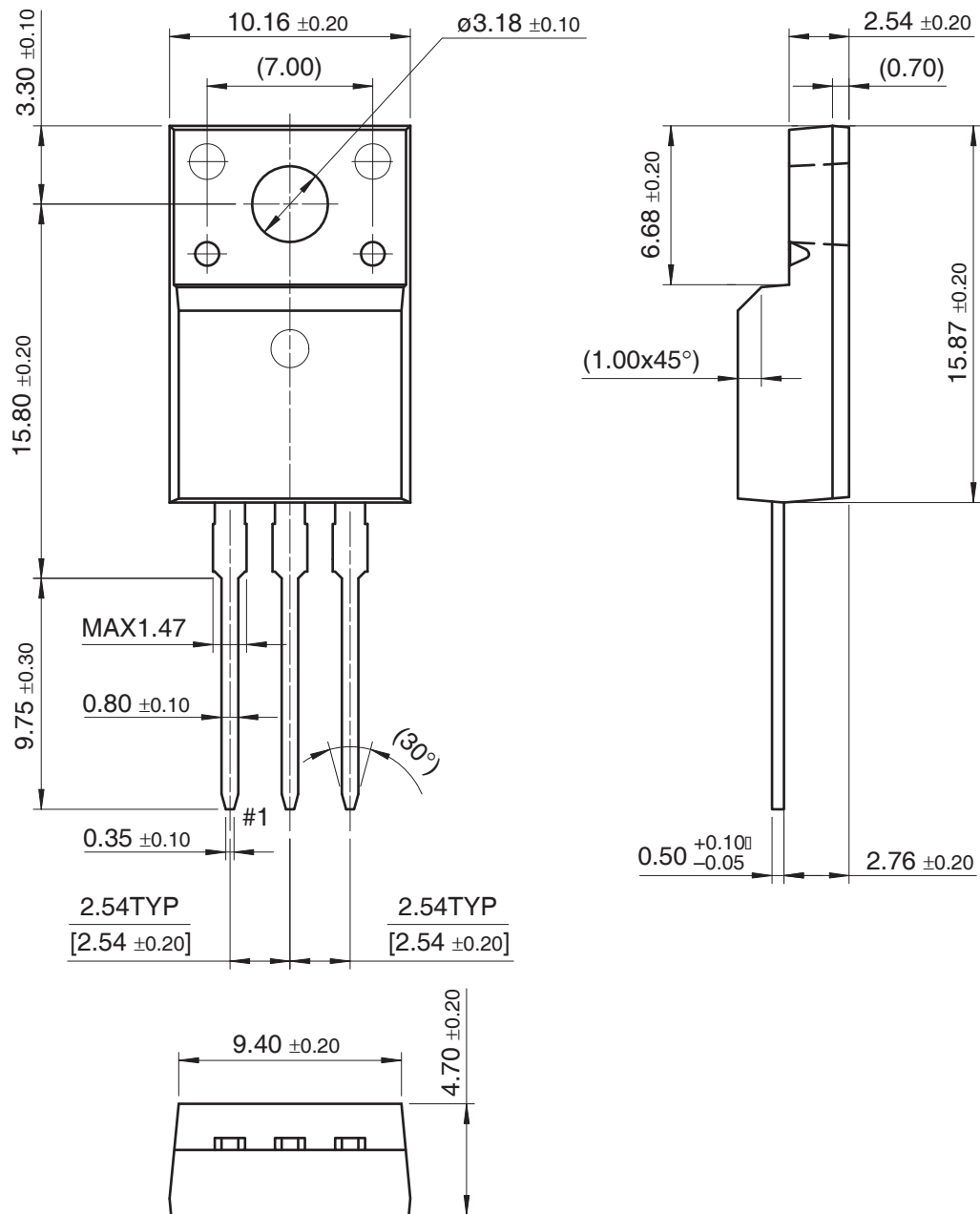


Dimensions in Millimeters



**Mechanical Dimensions** (Continued)

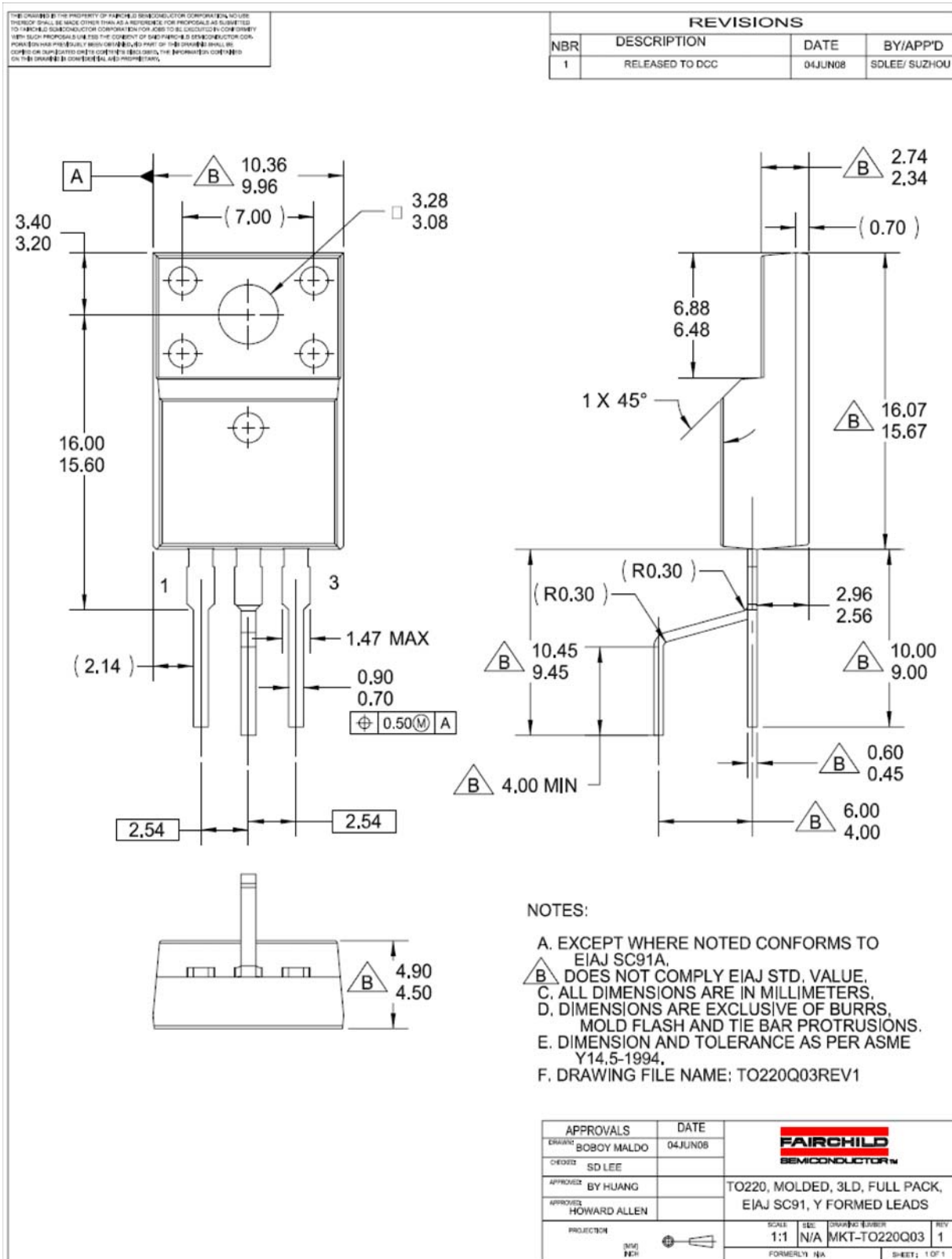
**TO-220F**



Dimensions in Millimeters

## Mechanical Dimensions (Continued)

## TO-220F (Y Forming)



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| Bottomless <sup>™</sup>                          | FPS <sup>™</sup>                | MICROCOUPLER <sup>™</sup> | PowerSaver <sup>™</sup>         | SuperSOT <sup>™</sup> -3    |
| CoolFET <sup>™</sup>                             | FRFET <sup>™</sup>              | MicroFET <sup>™</sup>     | PowerTrench <sup>®</sup>        | SuperSOT <sup>™</sup> -6    |
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### Definition of Terms

| Datasheet Identification | Product Status         | Definition                                                                                                                                                                                                            |
|--------------------------|------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Advance Information      | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.                                                                                    |
| Preliminary              | First Production       | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
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